## SN54ALVTH162244, SN74ALVTH162244 2.5-V/3.3-V 16-BIT BUFFERS/DRIVERS WITH 3-STATE OUTPUTS

SCES074E - JUNE 1996 - REVISED JANUARY 1999

- State-of-the-Art Advanced BiCMOS Technology (ABT) Widebus™ Design for 2.5-V and 3.3-V Operation and Low Static **Power Dissipation**
- **Support Mixed-Mode Signal Operation (5-V** Input and Output Voltages With 2.3-V to 3.6-V V<sub>CC</sub>)
- Typical V<sub>OLP</sub> (Output Ground Bounce)  $< 0.8 \text{ V at V}_{CC} = 3.3 \text{ V}, T_A = 25^{\circ}\text{C}$
- **Power Off Disables Outputs, Permitting Live Insertion**
- **High-Impedance State During Power Up** and Power Down Prevents Driver Conflict
- Uses Bus Hold on Data Inputs in Place of External Pullup/Pulldown Resistors to **Prevent the Bus From Floating**
- Output Ports Have Equivalent 30- $\Omega$  Series Resistors, So No External Resistors Are Required
- **Auto3-State Eliminates Bus Current** Loading When Output Exceeds V<sub>CC</sub> + 0.5 V
- Latch-Up Performance Exceeds 250 mA Per **JESD 17**
- ESD Protection Exceeds 2000 V Per MIL-STD-883, Method 3015; Exceeds 200 V Using Machine Model; and Exceeds 1000 V Using Charged-Device Model, Robotic Method
- Flow-Through Architecture Facilitates **Printed Circuit Board Layout**
- Distributed V<sub>CC</sub> and GND Pin Configuration Minimizes High-Speed Switching Noise
- **Package Options Include Plastic Shrink** Small-Outline (DL), Thin Shrink Small-Outline (DGG), Thin Very Small-Outline (DGV) Packages, and 380-mil Fine-Pitch Ceramic Flat (WD) Package

NOTE: For order entry:

The DGG package is abbreviated to G, and the DGV package is abbreviated to V.

## description

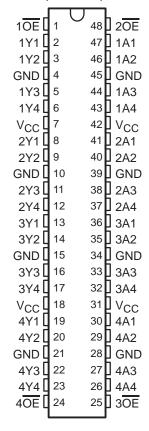
The 'ALVTH162244 devices are 16-bit buffers/line drivers designed for low-voltage 2.5-V or 3.3-V V<sub>CC</sub> operation, but with the capability to provide a TTL interface to a 5-V system environment.



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SN54ALVTH162244 . . . WD PACKAGE SN74ALVTH162244 . . . DGG, DGV, OR DL PACKAGE (TOP VIEW)



### description (continued)

These devices can be used as four 4-bit buffers, two 8-bit buffers, or one 16-bit buffer. These devices provide true outputs and symmetrical active-low output-enable  $(\overline{OE})$  inputs.

Active bus-hold circuitry is provided to hold unused or floating data inputs at a valid logic level.

When  $V_{CC}$  is between 0 and 1.2 V, the device is in the high-impedance state during power up or power down. However, to ensure the high-impedance state above 1.2 V,  $\overline{OE}$  should be tied to  $V_{CC}$  through a pullup resistor; the minimum value of the resistor is determined by the current-sinking capability of the driver.

All outputs are designed to sink up to 12 mA and include equivalent  $30-\Omega$  resistors to reduce overshoot and undershoot.

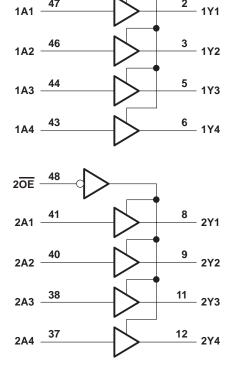
The SN54ALVTH162244 is characterized for operation over the full military temperature range of –55°C to 125°C. The SN74ALVTH162244 is characterized for operation from –40°C to 85°C.

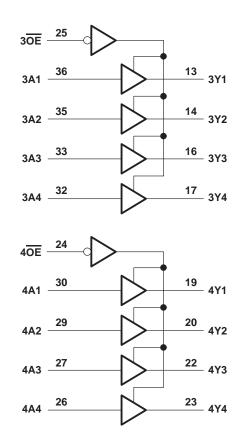
## FUNCTION TABLE (each 4-bit buffer)

| INP | UTS | OUTPUT |
|-----|-----|--------|
| OE  | Α   | Υ      |
| L   | Н   | Н      |
| L   | L   | L      |
| Н   | X   | Z      |

### logic diagram (positive logic)

10E







## absolute maximum ratings over operating free-air temperature range (unless otherwise noted)†

| Supply voltage range, V <sub>CC</sub>  | 0.5 V to 4.6 V |
|--|----------------|
| Input voltage range, V <sub>I</sub> (see Note 1)                                   | 0.5 V to 7 V   |
| Voltage range applied to any output in the high-impedance                          |                |
| or power-off state, V <sub>O</sub> (see Note 1)                                    | 0.5 V to 7 V   |
| Voltage range applied to any output in the high state, V <sub>O</sub> (see Note 1) | 0.5 V to 7 V   |
| Output current in the low state, I <sub>O</sub>                                    | 30 mA          |
| Output current in the high state, I <sub>O</sub>                                   | –30 mA         |
| Input clamp current, $I_{IK}$ ( $V_I < 0$ )  |                |
| Output clamp current, $I_{OK}$ ( $V_O < 0$ )                                       | –50 mA         |
| Package thermal impedance, θ <sub>JA</sub> (see Note 2): DGG package               | 89°C/W         |
| DGV package  | 93°C/W         |
| DL package   | 94°C/W         |
| Storage temperature range, T <sub>stq</sub>  |                |

<sup>†</sup> Stresses beyond those listed under "absolute maximum ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated under "recommended operating conditions" is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.

NOTES: 1. The input and output negative-voltage ratings may be exceeded if the input and output clamp-current ratings are observed.

2. The package thermal impedance is calculated in accordance with JESD 51.

## recommended operating conditions, $V_{CC}$ = 2.5 V $\pm$ 0.2 V (see Note 3)

|                     |                                    |                 | SN54A | LVTH16 | 62244 | SN74A | LVTH16 | 2244 | UNIT |
|---------------------|------------------------------------|-----------------|-------|--------|-------|-------|--------|------|------|
|                     |                                    |                 | MIN   | TYP    | MAX   | MIN   | TYP    | MAX  | UNIT |
| VCC                 | Supply voltage                     |                 | 2.3   |        | 2.7   | 2.3   |        | 2.7  | V    |
| VIH                 | High-level input voltage           |                 | 1.7   |        | 1/2   | 1.7   |        |      | V    |
| V <sub>IL</sub>     | Low-level input voltage            |                 |       | Š      | 0.7   |       |        | 0.7  | V    |
| VI                  | Input voltage                      |                 | 0     | Vcc    | 5.5   | 0     | VCC    | 5.5  | V    |
| ІОН                 | High-level output current          |                 |       | 1      | -6    |       |        | -8   | mA   |
| loL                 | Low-level output current           |                 |       | 2      | 8     |       |        | 12   | mA   |
| Δt/Δν               | Input transition rise or fall rate | Outputs enabled | 0/0/  | 7      | 10    |       |        | 10   | ns/V |
| Δt/ΔV <sub>CC</sub> | Power-up ramp rate                 | ·               | 200   |        |       | 200   |        |      | μs/V |
| TA                  | Operating free-air temperature     |                 | -55   |        | 125   | -40   |        | 85   | °C   |

NOTE 3: All unused control inputs of the device must be held at V<sub>CC</sub> or GND to ensure proper device operation. Refer to the TI application report, Implications of Slow or Floating CMOS Inputs, literature number SCBA004.

## recommended operating conditions, $V_{CC}$ = 3.3 V $\pm$ 0.3 V (see Note 3)

|                 |                                    |                 | SN54A | LVTH16 | 2244 | SN74A | ALVTH16 | 62244 | UNIT |
|-----------------|------------------------------------|-----------------|-------|--------|------|-------|---------|-------|------|
|                 |                                    |                 | MIN   | TYP    | MAX  | MIN   | TYP     | MAX   | UNII |
| Vcc             | Supply voltage                     |                 | 3     |        | 3.6  | 3     |         | 3.6   | V    |
| VIH             | High-level input voltage           |                 | 2     |        | 7    | 2     |         |       | V    |
| V <sub>IL</sub> | Low-level input voltage            |                 |       | Š      | 0.8  |       |         | 0.8   | V    |
| VI              | Input voltage                      |                 | 0     | Vcc.   | 5.5  | 0     | VCC     | 5.5   | V    |
| loн             | High-level output current          |                 |       | 7      | -8   |       |         | -12   | mA   |
| l <sub>OL</sub> | Low-level output current           |                 |       | 25     | 8    |       |         | 12    | mA   |
| Δt/Δν           | Input transition rise or fall rate | Outputs enabled |       | 5      | 10   |       |         | 10    | ns/V |
| Δt/ΔVCC         | Power-up ramp rate                 |                 | 200   |        |      | 200   |         |       | μs/V |
| T <sub>A</sub>  | Operating free-air temperature     |                 | -55   |        | 125  | -40   |         | 85    | °C   |

NOTE 3: All unused control inputs of the device must be held at V<sub>CC</sub> or GND to ensure proper device operation. Refer to the TI application report, Implications of Slow or Floating CMOS Inputs, literature number SCBA004.



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## electrical characteristics over recommended operating free-air temperature range, $V_{CC}$ = 2.5 V $\pm$ 0.2 V (unless otherwise noted)

| DAI                | RAMETER     | TEST COM   | NDITIONS  | SN54ALVTH            | 162244 | SN74               | ALVTH16          | 52244      | UNIT |
|--------------------|-------------|--|---|----------------------|--------|--------------------|------------------|------------|------|
| PAI                | RAMETER     | TEST COI   | NDITIONS  | MIN TYPT             | MAX    | MIN                | TYP <sup>†</sup> | MAX        | UNIT |
| ٧ıK                |             | $V_{CC} = 2.3 \text{ V},$  | $I_{I} = -18 \text{ mA}$  |                      | -1.2   |                    |                  | -1.2       | V    |
|                    |             | $V_{CC} = 2.3 \text{ V to } 2.7 \text{ V},$  | $I_{OH} = -100  \mu A$  | V <sub>CC</sub> -0.2 |        | V <sub>CC</sub> -0 | .2               |            |      |
| Vон                |             | V <sub>CC</sub> = 2.3 V  | $I_{OH} = -6 \text{ mA}$  | 1.7                  |        |                    |                  |            | V    |
|                    |             | VCC = 2.3 V  | $I_{OH} = -8 \text{ mA}$  |                      |        | 1.7                |                  |            |      |
|                    |             | $V_{CC} = 2.3 \text{ V to } 2.7 \text{ V},$  | $I_{OL} = 100 \mu\text{A}$  |                      | 0.2    |                    |                  | 0.2        |      |
| VOL                |             | V <sub>CC</sub> = 2.3 V  | $I_{OL} = 8 \text{ mA}$   |                      | 0.7    |                    |                  |            | V    |
|                    | _           | VCC = 2.5 V  | $I_{OL} = 12 \text{ mA}$  |                      |        |                    |                  | 0.7        |      |
|                    | Control     | $V_{CC} = 2.7 \text{ V},$  | $V_I = V_{CC}$ or GND   |                      | ±1     |                    |                  | ±1         |      |
|                    | inputs      | $V_{CC} = 0 \text{ or } 2.7 \text{ V},$  | V <sub>I</sub> = 5.5 V  |                      | 10     |                    |                  | 10         |      |
| Ц                  |             |  | V <sub>I</sub> = 5.5 V  |                      | 10     |                    |                  | 10         | μΑ   |
|                    | Data inputs | V <sub>CC</sub> = 2.7 V  | VI = VCC  |                      | 1 کی   |                    |                  | 1          |      |
|                    |             |  | V <sub>I</sub> = 0  |                      | _5     |                    |                  | <b>–</b> 5 |      |
| l <sub>off</sub>   |             | $V_{CC} = 0$ ,   | $V_I$ or $V_O = 0$ to 4.5 $V$                                     | Q                    | 9      |                    |                  | ±100       | μΑ   |
| I <sub>BHL</sub> ‡ |             | $V_{CC} = 2.3 \text{ V},$  | V <sub>I</sub> = 0.7 V  | 415                  |        |                    | 115              |            | μΑ   |
| I <sub>BHH</sub> § |             | $V_{CC} = 2.3 \text{ V},$  | V <sub>I</sub> = 1.7 V  | 5-10                 |        |                    | -10              |            | μΑ   |
| <sup>I</sup> BHLO  |             | $V_{CC} = 2.7 \text{ V},$  | $V_I = 0$ to $V_{CC}$   | 300                  |        | 300                |                  |            | μΑ   |
| Івнно              | #           | $V_{CC} = 2.7 \text{ V},$  | $V_I = 0$ to $V_{CC}$   | -300                 |        | -300               |                  |            | μΑ   |
| IEX                |             | $V_{CC} = 2.3 \text{ V},$  | $V_0 = 5.5 \text{ V}$   |                      | 125    |                    |                  | 125        | μΑ   |
| IOZ(PL             | J/PD)☆      | $V_{CC} \le 1.2 \text{ V}, V_{O} = \underline{0.5} \text{ V to}$<br>$V_{I} = \text{GND or } V_{CC}, \overline{OE} = \text{do}$ | V <sub>CC</sub> ,<br>on't care                                    |                      | ±100   |                    |                  | ±100       | μΑ   |
| lozh               |             | V <sub>CC</sub> = 2.7 V  | $V_O = 2.3 \text{ V},$<br>$V_I = 0.7 \text{ V or } 1.7 \text{ V}$ |                      | 5      |                    |                  | 5          | μА   |
| lozL               |             | V <sub>CC</sub> = 2.7 V  | $V_O = 0.5 \text{ V},$<br>$V_I = 0.7 \text{ V or } 1.7 \text{ V}$ |                      | -5     |                    |                  | <b>-</b> 5 | μΑ   |
|                    |             | V <sub>CC</sub> = 2.7 V,   | Outputs high  | 0.04                 | 0.1    |                    | 0.04             | 0.1        |      |
| Icc                |             | $I_{O} = 0$ ,  | Outputs low   | 2.3                  | 4.5    |                    | 2.3              | 4.5        | mA   |
|                    |             | $V_I = V_{CC}$ or GND  | Outputs disabled  | 0.04                 | 0.1    |                    | 0.04             | 0.1        |      |
| Ci                 |             | V <sub>CC</sub> = 2.5 V,   | V <sub>I</sub> = 2.5 V or 0                                       | 3                    |        |                    | 3                |            | pF   |
| Co                 |             | V <sub>CC</sub> = 2.5 V,   | V <sub>O</sub> = 2.5 V or 0                                       | 6                    |        |                    | 6                |            | pF   |

<sup>&</sup>lt;sup>†</sup> All typical values are at  $V_{CC} = 2.5 \text{ V}$ ,  $T_A = 25^{\circ}\text{C}$ .

<sup>‡</sup> The bus-hold circuit can sink at least the minimum low sustaining current at V<sub>IL</sub> max. I<sub>BHL</sub> should be measured after lowering V<sub>IN</sub> to GND and then raising it to V<sub>IL</sub> max.

<sup>§</sup> The bus-hold circuit can source at least the minimum high sustaining current at V<sub>IH</sub> min. I<sub>BHH</sub> should be measured after raising V<sub>IN</sub> to V<sub>CC</sub> and then lowering it to V<sub>IH</sub> min.

 $<sup>\</sup>P$  An external driver must source at least  $I_{\mbox{\footnotesize{BHLO}}}$  to switch this node from low to high.

<sup>#</sup> An external driver must sink at least IBHHO to switch this node from high to low.

 $<sup>\</sup>parallel$  Current into an output in the high state when  $\vee_{O} > \vee_{CC}$ 

<sup>\*</sup>High-impedance state during power up or power down

## electrical characteristics over recommended operating free-air temperature range, $V_{CC}$ = 3.3 V $\pm$ 0.3 V (unless otherwise noted)

| DA                 | DAMETED        | TEST OF  | NUNTIONS   | SN54ALVTH1           | 62244      | SN74               | ALVTH16 | 62244      | UNIT |
|--------------------|----------------|--|--|----------------------|------------|--------------------|---------|------------|------|
| FA                 | RAMETER        | TEST CC  | ONDITIONS  | MIN TYPT             | MAX        | MIN                | TYP†    | MAX        | UNII |
| ٧ıK                |                | V <sub>CC</sub> = 3 V,   | I <sub>I</sub> = -18 mA                                  |                      | -1.2       |                    |         | -1.2       | V    |
|                    |                | $V_{CC} = 3 \text{ V to } 3.6 \text{ V},$  | I <sub>OH</sub> = -100 μA                                | V <sub>CC</sub> -0.2 |            | V <sub>CC</sub> -0 | .2      |            |      |
| VOH                |                | VCC = 3 V  | $I_{OH} = -8 \text{ mA}$                                 | 2                    |            |                    |         |            | V    |
|                    |                | ACC = 2 A  | $I_{OH} = -12 \text{ mA}$                                |                      |            | 2                  |         |            |      |
|                    |                | $V_{CC} = 3 \text{ V to } 3.6 \text{ V},$  | $I_{OL} = 100 \mu\text{A}$                               |                      | 0.2        |                    |         | 0.2        |      |
| VOL                |                | VCC = 3 V  | $I_{OL} = 8 \text{ mA}$                                  |                      | 0.8        |                    |         |            | V    |
|                    |                | VCC = 3 V  | $I_{OL} = 12 \text{ mA}$                                 |                      |            |                    |         | 0.8        |      |
|                    | Control        | $V_{CC} = 3.6 \text{ V},$  | $V_I = V_{CC}$ or GND                                    |                      | ±1         |                    |         | ±1         |      |
|                    | inputs         | V <sub>CC</sub> = 0 or 3.6 V   | V <sub>I</sub> = 5.5 V                                   |                      | 10         |                    |         | 10         |      |
| lį                 |                |  | V <sub>I</sub> = 5.5 V                                   |                      | 10         |                    |         | 10         | μΑ   |
|                    | Data inputs    | V <sub>CC</sub> = 3.6 V  | VI = VCC   |                      | \$ 1       |                    |         | 1          |      |
|                    |                |  | V <sub>I</sub> = 0                                       |                      | <b>–</b> 5 |                    |         | <b>–</b> 5 |      |
| l <sub>off</sub>   |                | $V_{CC} = 0$ ,   | $V_I$ or $V_O = 0$ to 4.5 $V$                            | Q.                   |            |                    |         | ±100       | μΑ   |
| I <sub>BHL</sub> ‡ |                | $V_{CC} = 3 V$   | V <sub>I</sub> = 0.8 V                                   | 75                   |            | 75                 |         |            | μΑ   |
| I <sub>BHH</sub> § |                | $V_{CC} = 3 V$ ,   | V <sub>I</sub> = 2 V                                     | -75                  |            | -75                |         |            | μΑ   |
| IBHLO              |                | V <sub>CC</sub> = 3.6 V,   | $V_I = 0$ to $V_{CC}$                                    | 500                  |            | 500                |         |            | μΑ   |
| Івнно              | ) <sup>#</sup> | V <sub>CC</sub> = 3.6 V,   | $V_I = 0$ to $V_{CC}$                                    | -500                 |            | -500               |         |            | μΑ   |
| <sub>IEX</sub>     |                | V <sub>CC</sub> = 3 V,   | V <sub>O</sub> = 5.5 V                                   |                      | 125        |                    |         | 125        | μΑ   |
| IOZ(PU             | J/PD)☆         | $V_{CC} \le 1.2 \text{ V}, V_{O} = 0.5 \text{ V}$<br>$V_{I} = \text{GND or } V_{CC}, \overline{OE} = 0.00 \text{ V}$ | to V <sub>CC</sub> ,<br>don't care                       |                      | ±100       |                    |         | ±100       | μΑ   |
| lozh               |                | V <sub>CC</sub> = 3.6 V  | V <sub>O</sub> = 3 V,<br>V <sub>I</sub> = 0.8 V or 2 V   |                      | 5          |                    |         | 5          | μΑ   |
| lozL               |                | V <sub>CC</sub> = 3.6 V  | V <sub>O</sub> = 0.5 V,<br>V <sub>I</sub> = 0.8 V or 2 V |                      | -5         |                    |         | <b>-</b> 5 | μΑ   |
|                    |                | V <sub>CC</sub> = 3.6 V,   | Outputs high   | 0.07                 | 0.1        |                    | 0.07    | 0.1        |      |
| ICC                |                | $I_{O} = 0$ ,  | Outputs low  | 3.2                  | 5          |                    | 3.2     | 5          | mA   |
|                    |                | $V_I = V_{CC}$ or GND  | Outputs disabled   | 0.07                 | 0.1        |                    | 0.07    | 0.1        |      |
| ΔlCC□              | 1              | V <sub>CC</sub> = 3 V to 3.6 V, One<br>Other inputs at V <sub>CC</sub> or G  |  |                      | 0.4        |                    |         | 0.4        | mA   |
| Ci                 |                | V <sub>CC</sub> = 3.3 V,   | V <sub>I</sub> = 3.3 V or 0                              | 3                    |            |                    | 3       |            | pF   |
| Со                 |                | V <sub>CC</sub> = 3.3 V,   | V <sub>O</sub> = 3.3 V or 0                              | 6                    |            |                    | 6       |            | pF   |

<sup>&</sup>lt;sup>†</sup> All typical values are at  $V_{CC} = 3.3 \text{ V}$ ,  $T_A = 25^{\circ}\text{C}$ .

<sup>&</sup>lt;sup>‡</sup> The bus-hold circuit can sink at least the minimum low sustaining current at V<sub>IL</sub> max. I<sub>BHL</sub> should be measured after lowering V<sub>IN</sub> to GND and then raising it to V<sub>IL</sub> max.

<sup>§</sup> The bus-hold circuit can source at least the minimum high sustaining current at VIH min. IBHH should be measured after raising VIN to VCC and then lowering it to VIH min.

<sup>¶</sup> An external driver must source at least IBHLO to switch this node from low to high.

<sup>#</sup> An external driver must sink at least I<sub>BHHO</sub> to switch this node from high to low.

Current into an output in the high state when VO > VCC

<sup>\*</sup>High-impedance state during power up or power down

<sup>□</sup>This is the increase in supply current for each input that is at the specified TTL voltage level rather than V<sub>CC</sub> or GND.

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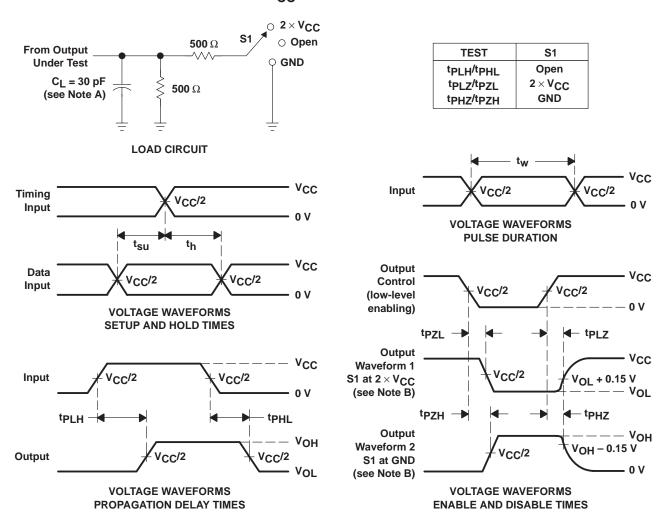
## switching characteristics over recommended operating free-air temperature range, $C_L$ = 30 pF, $V_{CC}$ = 2.5 V $\pm$ 0.2 V (unless otherwise noted) (see Figure 1)

| PARAMETER        | FROM    | то       | SN54ALVT | H162244 | SN74ALVTH | 1162244 | UNIT |
|------------------|---------|----------|----------|---------|-----------|---------|------|
| PARAMETER        | (INPUT) | (OUTPUT) | MIN      | MAX     | MIN       | MAX     | UNII |
| t <sub>PLH</sub> |         | V        | 1        | 4.3     | 1         | 4.2     | ns   |
| <sup>t</sup> PHL | А       | ı        | 1.4      | 3.8     | 1.5       | 3.7     | 115  |
| <sup>t</sup> PZH | ŌĒ      | V        | 1.3      | 6.9     | 1.4       | 6.8     | ns   |
| <sup>t</sup> PZL | OE .    | ı        | 1.3      | 5.2     | 1.4       | 5.1     | 115  |
| <sup>t</sup> PHZ | ŌĒ      | V        | 0        | 4.7     | 1         | 4.6     | ns   |
| t <sub>PLZ</sub> | OE .    | ı        | Q 1      | 3.6     | 1         | 3.5     | 115  |

# switching characteristics over recommended operating free-air temperature range, $C_L$ = 50 pF, $V_{CC}$ = 3.3 V $\pm$ 0.3 V (unless otherwise noted) (see Figure 2)

| PARAMETER        | FROM    | то       | SN54ALVTH | 162244 | SN74ALVTI | UNIT |      |
|------------------|---------|----------|-----------|--------|-----------|------|------|
| PARAMETER        | (INPUT) | (OUTPUT) | MIN       | MAX    | MIN       | MAX  | UNII |
| <sup>t</sup> PLH | ۸       | V        | 1         | 3.4    | 1         | 3.3  | ns   |
| t <sub>PHL</sub> | А       | r        | 1         | 3.4    | 1         | 3.3  | 115  |
| <sup>t</sup> PZH | ŌĒ      | V        | 1.4       | 5      | 1.5       | 4.9  | ns   |
| t <sub>PZL</sub> | OE      | T        | 1.3       | 3.4    | 1.4       | 3.3  | 115  |
| <sup>t</sup> PHZ | ŌĒ      | V        | 1.4       | 5      | 1.5       | 4.9  | ns   |
| t <sub>PLZ</sub> | OE .    | '        | 21.4      | 4.4    | 1.5       | 4.3  | 113  |

## PARAMETER MEASUREMENT INFORMATION $V_{CC} = 2.5 \text{ V} \pm 0.2 \text{ V}$

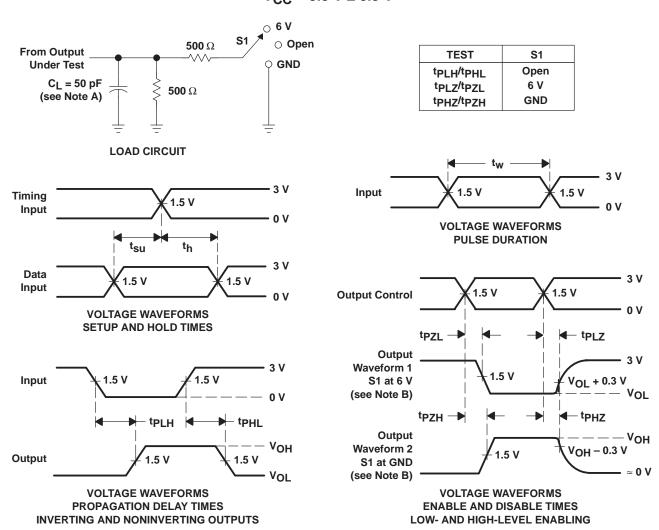


NOTES: A. C<sub>L</sub> includes probe and jig capacitance.

- B. Waveform 1 is for an output with internal conditions such that the output is low except when disabled by the output control. Waveform 2 is for an output with internal conditions such that the output is high except when disabled by the output control.
- C. All input pulses are supplied by generators having the following characteristics: PRR  $\leq$  10 MHz,  $Z_O = 50~\Omega$ ,  $t_f \leq$  2 ns,  $t_f \leq$  2 ns.
- D. The outputs are measured one at a time with one transition per measurement.

Figure 1. Load Circuit and Voltage Waveforms

## PARAMETER MEASUREMENT INFORMATION $V_{CC}$ = 3.3 V $\pm$ 0.3 V



- NOTES: A. C<sub>I</sub> includes probe and jig capacitance.
  - B. Waveform 1 is for an output with internal conditions such that the output is low except when disabled by the output control. Waveform22 is for an output with internal conditions such that the output is high except when disabled by the output control.
  - C. All input pulses are supplied by generators having the following characteristics: PRR  $\leq$  10 MHz,  $Z_O = 50 \,\Omega$ ,  $t_f \leq 2.5 \,\text{ns}$ ,  $t_f \leq 2.5 \,\text{ns}$ .
  - D. The outputs are measured one at a time with one transition per measurement.

Figure 2. Load Circuit and Voltage Waveforms







com 24-May-2007

#### **PACKAGING INFORMATION**

| Orderable Device  | Status <sup>(1)</sup> | Package<br>Type | Package<br>Drawing | Pins | Package<br>Qty | e Eco Plan <sup>(2)</sup> | Lead/Ball Finish | MSL Peak Temp <sup>(3)</sup> |
|-------------------|-----------------------|-----------------|--------------------|------|----------------|---------------------------|------------------|------------------------------|
| 74ALVTH162244DLG4 | ACTIVE                | SSOP            | DL                 | 48   | 25             | Green (RoHS & no Sb/Br)   | CU NIPDAU        | Level-1-260C-UNLIM           |
| 74ALVTH162244GRE4 | ACTIVE                | TSSOP           | DGG                | 48   | 2000           | Green (RoHS & no Sb/Br)   | CU NIPDAU        | Level-1-260C-UNLIM           |
| 74ALVTH162244LRG4 | ACTIVE                | SSOP            | DL                 | 48   | 1000           | Green (RoHS & no Sb/Br)   | CU NIPDAU        | Level-1-260C-UNLIM           |
| 74ALVTH162244VRE4 | ACTIVE                | TVSOP           | DGV                | 48   | 2000           | Green (RoHS & no Sb/Br)   | CU NIPDAU        | Level-1-260C-UNLIM           |
| 74ALVTH162244VRG4 | ACTIVE                | TVSOP           | DGV                | 48   | 2000           | Green (RoHS & no Sb/Br)   | CU NIPDAU        | Level-1-260C-UNLIM           |
| SN74ALVTH162244DL | ACTIVE                | SSOP            | DL                 | 48   | 25             | Green (RoHS & no Sb/Br)   | CU NIPDAU        | Level-1-260C-UNLIM           |
| SN74ALVTH162244GR | ACTIVE                | TSSOP           | DGG                | 48   | 2000           | Green (RoHS & no Sb/Br)   | CU NIPDAU        | Level-1-260C-UNLIM           |
| SN74ALVTH162244LR | ACTIVE                | SSOP            | DL                 | 48   | 1000           | Green (RoHS & no Sb/Br)   | CU NIPDAU        | Level-1-260C-UNLIM           |
| SN74ALVTH162244VR | ACTIVE                | TVSOP           | DGV                | 48   | 2000           | Green (RoHS & no Sb/Br)   | CU NIPDAU        | Level-1-260C-UNLIM           |

(1) The marketing status values are defined as follows:

ACTIVE: Product device recommended for new designs.

LIFEBUY: TI has announced that the device will be discontinued, and a lifetime-buy period is in effect.

**NRND:** Not recommended for new designs. Device is in production to support existing customers, but TI does not recommend using this part in a new design.

PREVIEW: Device has been announced but is not in production. Samples may or may not be available.

**OBSOLETE:** TI has discontinued the production of the device.

(2) Eco Plan - The planned eco-friendly classification: Pb-Free (RoHS), Pb-Free (RoHS Exempt), or Green (RoHS & no Sb/Br) - please check http://www.ti.com/productcontent for the latest availability information and additional product content details.

TBD: The Pb-Free/Green conversion plan has not been defined.

**Pb-Free** (RoHS): TI's terms "Lead-Free" or "Pb-Free" mean semiconductor products that are compatible with the current RoHS requirements for all 6 substances, including the requirement that lead not exceed 0.1% by weight in homogeneous materials. Where designed to be soldered at high temperatures, TI Pb-Free products are suitable for use in specified lead-free processes.

**Pb-Free (RoHS Exempt):** This component has a RoHS exemption for either 1) lead-based flip-chip solder bumps used between the die and package, or 2) lead-based die adhesive used between the die and leadframe. The component is otherwise considered Pb-Free (RoHS compatible) as defined above.

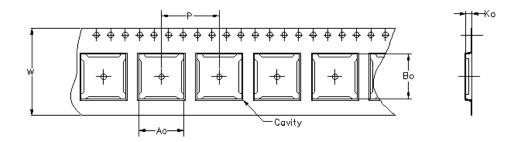
Green (RoHS & no Sb/Br): TI defines "Green" to mean Pb-Free (RoHS compatible), and free of Bromine (Br) and Antimony (Sb) based flame retardants (Br or Sb do not exceed 0.1% by weight in homogeneous material)

(3) MSL, Peak Temp. -- The Moisture Sensitivity Level rating according to the JEDEC industry standard classifications, and peak solder temperature.

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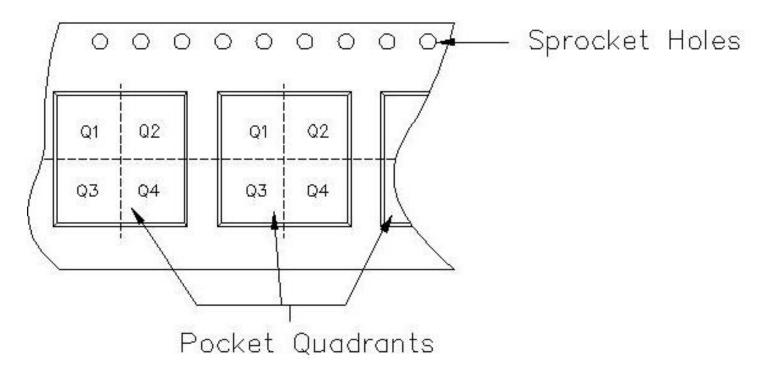
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Carrier tape design is defined largely by the component lentgh, width, and thickness.

| Ao = | Dimension    | designed  | to   | accommodate     | the | component | width.     |
|------|--------------|-----------|------|-----------------|-----|-----------|------------|
| Bo = | Dímension    | designed  | to   | accommodate     | the | component | length.    |
| Ko = | Dímension    | designed  | to   | accommodate     | the | component | thickness. |
| W =  | Overall widt | h of the  | car  | rier tape.      |     |           |            |
| P =  | Pitch betwe  | en succes | ssiv | e cavity center | ຮ.  |           |            |



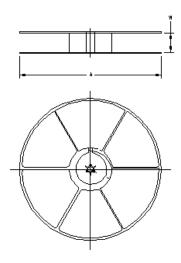
#### TAPE AND REEL INFORMATION



## **PACKAGE MATERIALS INFORMATION**

19-May-2007

| Device            | Package | Pins | Site | Reel<br>Diameter<br>(mm) | Reel<br>Width<br>(mm) | A0 (mm) | B0 (mm) | K0 (mm) | P1<br>(mm) | W<br>(mm) | Pin1<br>Quadrant |
|-------------------|---------|------|------|--------------------------|-----------------------|---------|---------|---------|------------|-----------|------------------|
| SN74ALVTH162244GR | DGG     | 48   | MLA  | 330                      | 24                    | 8.6     | 15.8    | 1.8     | 12         | 24        | Q1               |
| SN74ALVTH162244LR | DL      | 48   | MLA  | 330                      | 32                    | 11.35   | 16.2    | 3.1     | 16         | 32        | Q1               |
| SN74ALVTH162244VR | DGV     | 48   | MLA  | 330                      | 24                    | 6.8     | 10.1    | 1.6     | 12         | 24        | Q1               |



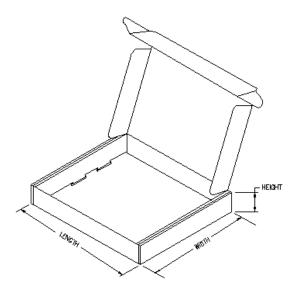
### TAPE AND REEL BOX INFORMATION

| Device            | Package | Pins | Site | Length (mm) | Width (mm) | Height (mm) |
|-------------------|---------|------|------|-------------|------------|-------------|
| SN74ALVTH162244GR | DGG     | 48   | MLA  | 333.2       | 333.2      | 31.75       |
| SN74ALVTH162244LR | DL      | 48   | MLA  | 336.6       | 342.9      | 41.3        |
| SN74ALVTH162244VR | DGV     | 48   | MLA  | 333.2       | 333.2      | 31.75       |





19-May-2007



### DGV (R-PDSO-G\*\*)

#### 24 PINS SHOWN

#### **PLASTIC SMALL-OUTLINE**



NOTES: A. All linear dimensions are in millimeters.

B. This drawing is subject to change without notice.

C. Body dimensions do not include mold flash or protrusion, not to exceed 0,15 per side.

D. Falls within JEDEC: 24/48 Pins – MO-153 14/16/20/56 Pins – MO-194

#### DL (R-PDSO-G\*\*)

#### **48 PINS SHOWN**

#### PLASTIC SMALL-OUTLINE PACKAGE



NOTES: A. All linear dimensions are in inches (millimeters).

B. This drawing is subject to change without notice.

C. Body dimensions do not include mold flash or protrusion not to exceed 0.006 (0,15).

D. Falls within JEDEC MO-118

### DGG (R-PDSO-G\*\*)

### PLASTIC SMALL-OUTLINE PACKAGE

#### **48 PINS SHOWN**



NOTES: A. All linear dimensions are in millimeters.

B. This drawing is subject to change without notice.

C. Body dimensions do not include mold protrusion not to exceed 0,15.

D. Falls within JEDEC MO-153

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